

Electronic Acknowledgement Receipt

EFS ID:	1390686
Application Number:	10712740
International Application Number:	
Confirmation Number:	8888
Title of Invention:	METHOD FOR FORMING A CONTACT USING A DUAL DAMASCENE PROCESS IN SEMICONDUCTOR FABRICATION
First Named Inventor/Applicant Name:	In Kyu Chun
Customer Number:	34431
Filer:	Andrew D. Fortney
Filer Authorized By:	
Attorney Docket Number:	20059/PIA30957
Receipt Date:	20-DEC-2006
Filing Date:	13-NOV-2003
Time Stamp:	20:37:53
Application Type:	Utility

Payment information:

Submitted with Payment	no
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part /.zip	Pages (if appl.)
1		PIA30957_DBE_US_POA_1 2-20-06.pdf	89557	yes	2

	Multipart Description/PDF files in .zip description		
	Document Description	Start	End
	Power of Attorney	1	1
	Assignee showing of ownership per 37 CFR 3.73(b).	2	2
Warnings:			
Information:			
Total Files Size (in bytes):		89557	
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